

Agilent HFCT-5750TL/TP/ATL/ATP Single Mode OC-12/STM-4 Small Form Factor Pluggable Transceivers *Part of the Agilent METRAK family* Data Sheet

Description

The HFCT-5750xxx Small Form Factor Pluggable LC optical transceivers are high performance, cost effective modules for serial data transmission at a signal rate of 622 Mbit/s. The transceivers are compliant with SONET/SDH and the Small Form Factor Pluggable (SFP) Multi-Source Agreement (MSA) specifications. They are designed for intermediate reach at 622 Mbit/s.

The transceivers operate at a nominal wavelength of 1300 nm over single mode fiber. The transmitter section incorporates a highly reliable Fabry Perot (FP) laser and uses an MOVPE grown planar PIN photodetector for low dark current and excellent responsivity on the receiver section.

The product meets all of the regulatory compliance listed in Table 3.



Features

- Compliant with ITU-T G.957 STM-4 S4.1 (15 km)
- Compliant with Telcordia GR253 OC-12 IR-1 (15 km) Optical Interface
- Multi-Source Agreement (MSA) compliant SFP package
- Hot-pluggable
- Multirate operation from 155 Mbit/s to 622 Mbit/s with full OC-3 and OC-12 SONET compliance
- Operating case temperature range:
 - 40 to +85 °C (ATL/ATP)
 - 10 to +85 °C (TL/TP)
- Optional extended de-latch for high density applications
 - standard de-latch
 - bail de-latch
- Manufactured in an ISO 9001 "compliant facility"
- Single +3.3 V power supply
- Class 1 CDRH/IEC 825 eye safety compliant
- LC Duplex fiber connector

Applications

OC-12 SFP transceivers are designed for ATM LAN and WAN applications such as:

- ATM switches and routers
- SONET/SDH switch infrastructure
- xDSL applications
- Metro edge switching

Related Products

- HFCT-595xx LC SFF PTH transceivers
- HDMP-3001 Ethernet Over SONET/SDH Mapper



Agilent Technologies

Functional Description

Receiver Section

Design

The receiver section for the HFCT-5750xxx contains an InGaAs/InP photo detector and a preamplifier mounted in an optical subassembly. This optical subassembly is coupled to a postamp/decision circuit on a circuit board.

The postamplifier is ac coupled to the preamplifier. The coupling capacitors are large enough to pass the SONET/SDH test pattern at 622 Mb/s without significant distortion or performance penalty. If a lower signal rate, or a code which has significantly more low frequency content is used, sensitivity, jitter and pulse distortion could be degraded.

There is a filter function which limits the bandwidth of the preamp output signal. The filter is designed to bandlimit the preamp output noise and thus improve the receiver sensitivity.

Loss of Signal

The Loss of Signal (LOS) output indicates that the optical input signal to the receiver does not meet the minimum detectable level for compliant signals. When LOS is high it indicates loss of signal. When LOS is low it indicates normal operation. The Loss of Signal thresholds are set to indicate a definite optical fault has occurred (eg., disconnected or broken fiber connection to receiver, failed transmitter).

Transmitter Section

Design

A schematic diagram for the transceiver is shown in Figure 1. The HFCT-5750xxx incorporates an FP laser as its optical source. All parts have been designed to be compliant with IEC 825 eye safety requirements under any single fault condition and CDRH under normal operating conditions. The optical output is controlled by a custom IC that detects the laser output via the monitor photodiode. This IC provides both dc and ac current drive to the laser to ensure correct modulation, eye diagram and extinction ratio over temperature, supply voltage and operating life.

Tx Fault

The HFCT-5750xxx module features a transmit fault control signal output which when high indicates a laser transmit fault has occurred and when low indicates normal laser operation. A transmitter fault condition can be caused by deviations from the recommended module operating conditions or by violation of eye safety conditions. A fault is cleared by cycling the Tx Disable control input.

Tx Disable

The HFCT-5750xxx accepts a transmit disable control signal input which shuts down the transmitter. A high signal implements this function while a low signal allows normal laser operation. In the event of a fault (eg., eye safety circuit activated), cycling this control signal resets the module. The Tx Disable control should be actuated upon initialization of the module.

HFCT-5750xx BLOCK DIAGRAM

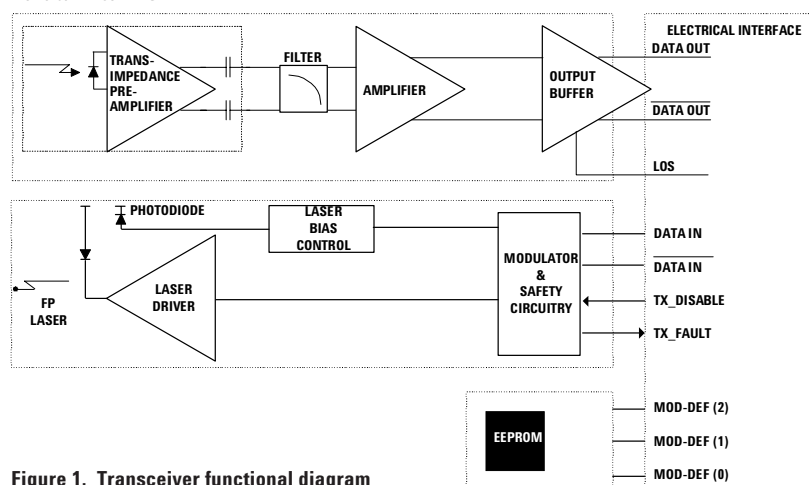


Figure 1. Transceiver functional diagram

Module Description

The transceiver meets the Small Form Pluggable (SFP) industry standard package utilizing an integral LC-Duplex optical interface connector. The hot-pluggable capability of the SFP package allows the module to be installed at any time - with the host system operating and on-line. This allows for system configuration changes or maintenance without system down time. The HFCT-5750xxx uses a reliable 1300 nm FP laser source and requires a 3.3 V dc power supply for optimal design.

Module Diagrams

Figure 1 illustrates the major functional components of the HFCT-5750xxx. The connection diagram of the module is shown in Figure 4. Figure 2 depicts the external configuration of the module. Figure 3 depicts the MSA recommended power supply filter.

Installation

The HFCT-5750xxx can be installed in or removed from any MultiSource Agreement (MSA) - compliant Small Form Pluggable port regardless of whether the host equipment is operating or not. The module is simply inserted, electrical interface first, under finger pressure. Controlled hot-plugging is ensured by design and by 3-stage pin sequencing at the electrical interface. The module housing makes initial contact with the host board EMI shield mitigating potential damage due to Electro-Static Discharge (ESD). The 3-stage pin contact sequencing involves (1) Ground, (2) Power, and then (3) Signal pins, making contact with the host board surface mount connector in that order.

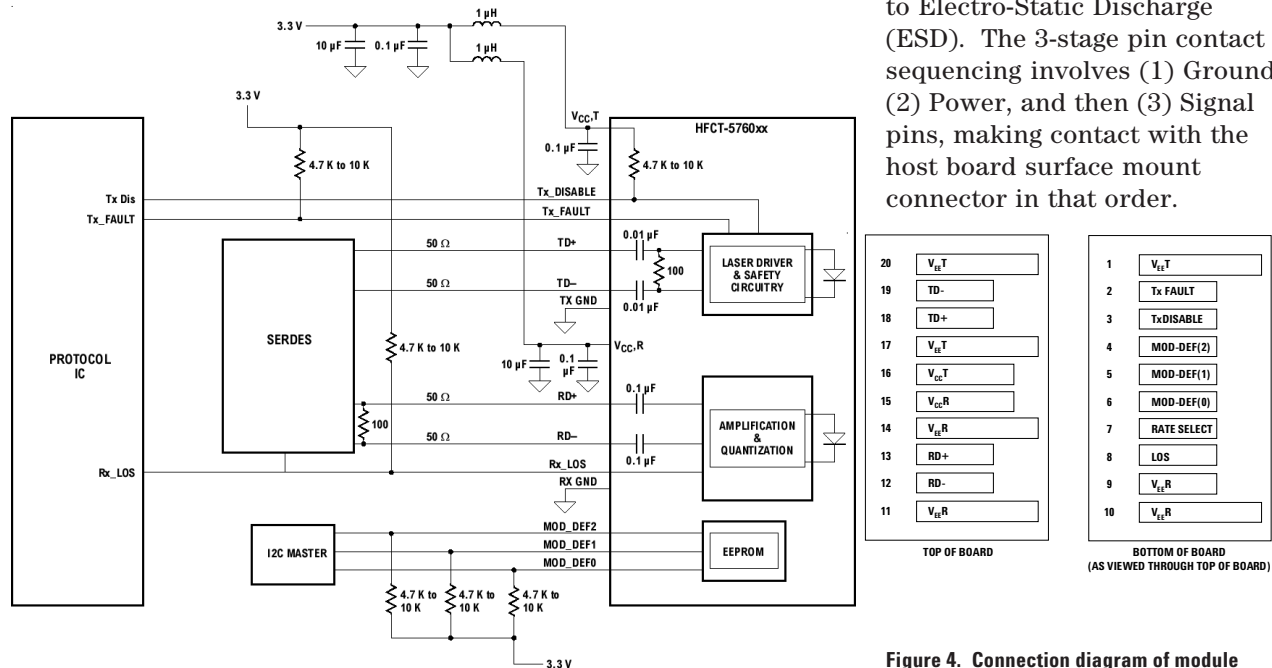
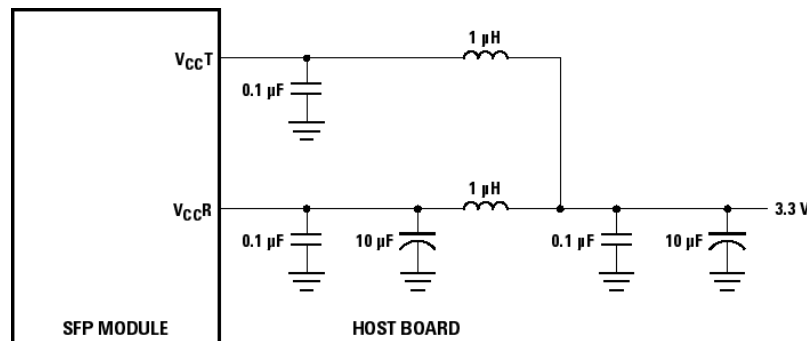


Figure 4. Connection diagram of module printed circuit board

Figure 2. Recommended application configuration



NOTE: INDUCTORS MUST HAVE LESS THAN 1 Ω SERIES RESISTANCE PER MSA.

Figure 3. MSA required power supply filter

Table 1. Pin-out Table

The pin arrangement and definition of this product meets SFP MSA. Table 1 lists the pin description.

Pin	Name	Function/Description	MSA Notes
1	VeeT	Transmitter Ground	
2	TX Fault	Transmitter Fault Indication	Note 1
3	TX Disable	Transmitter Disable - Module disables on high or open	Note 2
4	MOD-DEF2	Module Definition 2 - Two wire serial ID interface	Note 3
5	MOD-DEF1	Module Definition 1 - Two wire serial ID interface	Note 3
6	MOD-DEF0	Module Definition 0 - Grounded in module	Note 3
7	Rate Select	Not Connected	
8	LOS	Loss of Signal	Note 4
9	VeeR	Receiver Ground	Note 5
10	VeeR	Receiver Ground	Note 5
11	VeeR	Receiver Ground	Note 5
12	RD-	Inverse Received Data Out	Note 6
13	RD+	Received Data Out	Note 6
14	VeeR	Receiver Ground	Note 5
15	VccR	Receiver Power - 3.3 V $\pm 5\%$	Note 7
16	VccT	Transmitter Power - 3.3 V $\pm 5\%$	Note 7
17	VeeT	Transmitter Ground	Note 5
18	TD+	Transmitter Data In	Note 8
19	TD-	Inverse Transmitter Data In	Note 8
20	VeeT	Transmitter Ground	Note 5

Notes:

- TX Fault is an open collector/drain output which should be pulled up externally with a 4.7K – 10 K Ω resistor on the host board to a supply < Vcc+0.3 V. When high, this output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8 V.
- TX disable input is used to shut down the laser output per the state table below with an external 4.7-10 K Ω pull-up resistor.
Low (0 – 0.8 V): Transmitter on
Between (0.8 V and 2.0 V): Undefined
High (2.0 – 3.465 V): Transmitter Disabled
Open: Transmitter Disabled
- Mod-Def0,1,2. These are the module definition pins. They should be pulled up with a 4.7-10 K Ω resistor on the host board to a supply less than VccT +0.3 V or VccR+0.3 V.
Mod-Def 0 is grounded by the module to indicate that the module is present
Mod-Def 1 is clock line of two wire serial interface for optional serial ID
Mod-Def 2 is data line of two wire serial interface for optional serial ID
- LOS (Loss of Signal) is an open collector/drain output which should be pulled up externally with a 4.7K – 10K Ω resistor on the host board to a supply < VccT,R+0.3 V. When high, this output indicates the received optical power is below the worst case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to < 0.8 V. Please see later section for LOS timing.
- VeeR and VeeT may be internally connected within the SFP module
- RD-/+: These are the differential receiver outputs. They are ac coupled 100 Ω differential lines which should be terminated with 100 Ω differential at the user SERDES. The ac coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 370 and 2000 mV differential (185 – 1000 mV single ended) when properly terminated.
- VccR and VccT are the receiver and transmitter power supplies. They are defined as 3.1 – 3.5 V at the SFP connector pin. The maximum supply current is 300 mA.
- TD-/+: These are the differential transmitter inputs. They are ac coupled differential lines with 100 Ω differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 500 – 2400 mV (250 – 1200 mV single ended).

Serial Identification (EEPROM)

The HFCT-5750xx is compliant with the SFP MSA, which

defines the serial identification protocol. This protocol uses the 2-wire serial CMOS E2PROM protocol of the ATMEL

AT24C01A or similar. MSA compliant, example contents of the HFCT-5750xx serial ID memory are defined in Table 2.

Table 2. EEPROM Serial ID Memory Contents

Addr	Hex	ASCII	Addr	Hex	ASCII	Addr	Hex	ASCII	Addr	Hex	ASCII
0	03		40		H	68	Note 1		96	Note 1	
1	04		41		F	69	Note 1		97	Note 1	
2	07		42		C	70	Note 1		98	Note 1	
3	00		43		T	71	Note 1		99	Note 1	
4	00		44		-	72	Note 1		100	Note 1	
5	20		45		5	73	Note 1		101	Note 1	
6	00		46		7	74	Note 1		102	Note 1	
7	00		47		5	75	Note 1		103	Note 1	
8	00		48		0	76	Note 1		104	Note 1	
9	00		49		x	77	Note 1		105	Note 1	
10	00		50		x	78	Note 1		106	Note 1	
11	03		51	20		79	Note 1		107	Note 1	
12	06		52	20		80	Note 1		108	Note 1	
13	00		53	20		81	Note 1		109	Note 1	
14	0F		54	20		82	Note 1		110	Note 1	
15	96		55	20		83	Note 1		111	Note 1	
16	00		56	20		84	Note 2		112	Note 1	
17	00		57	20		85	Note 2		113	Note 1	
18	00		58	20		86	Note 2		114	Note 1	
19	00		59	20		87	Note 2		115	Note 1	
20	41	A	60	00		88	Note 2		116	Note 1	
21	47	G	61	00		89	Note 2		117	Note 1	
22	49	I	62	00		90	Note 2		118	Note 1	
23	4C	L	63	Note 3		91	Note 2		119	Note 1	
24	45	E	64	00		92	0		120	Note 1	
25	4E	N	65	1A		93	0		121	Note 1	
26	54	T	66	00		94	0		122	Note 1	
27	20		67	00		95	Note 3		123	Note 1	
28	20								124	Note 1	
29	20								125	Note 1	
30	20								126	Note 1	
31	20								127	Note 1	
32	20										
33	20										
34	20										
35	20										
36	00										
37	00										
38	30										
39	D3										

Notes:

1. Address 68-83 specify a unique identifier.
2. Address 84-91 specify the date code.
3. Addresses 63 and 95 are check sums. Address 63 is the check sum for bytes 0-62 and address 95 is the check sum for bytes 64-94.

Optical Parameters

Absolute Maximum Ratings

Absolute maximum ratings are those values beyond which functional performance is not intended, device reliability is not implied, and damage to the device may occur.

Parameter	Symbol	Minimum	Maximum	Unit	Notes
Storage Temperature (non-operating)	T _S	-40	+85	° C	
Relative Humidity	RH	0	85	%	
Supply Voltage	V _{CC}	-0.5	3.63	V	
Input Voltage on any Pin	V _I	-0.5	V _{CC}	V	
Receiver Optical Input	P _{IN} ABS		6	dBm	

Recommended Multirate Operating Conditions

Typical operating conditions are those values for which functional performance and device reliability is implied.

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Case Operating Temperature						
HFCT-5750TL/TP	T _A	-10		+85	°C	1
HFCT-5750ATL/ATP	T _A	-40		+85	°C	
Supply Voltage	V _{CC}	3.1	3.3	3.5	V	

Notes:

1. Operating conditions: +70 °C ambient, air flow 0.5 ms-1

Transceiver Electrical Characteristics for multirate operation at OC-3 (155 Mbit/s) and OC-12 (622 Mbit/s)

HFCT-5750TL/TP: T_C = -10 °C to +85 °C

HFCT-5750ATL/ATP: T_C = -40 °C to +85 °C

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Module supply current	I _{CC} T			250	mA	1
Power Dissipation	P _{DISS}			875	mW	
AC Electrical Characteristics						
Power Supply Noise Rejection	PSNR	100			mV	2
In-rush Current				30	mA	3
DC Electrical Characteristics						
Signal Outputs:						
Transmit Fault (TX_FAULT)	V _{OH}	2.0		3.5	V	4
Loss of Signal (LOS)	V _{OL}	0		0.8	V	
Signal Inputs:						
Transmitter Disable (TX_DISABLE)	V _{IH}	2.0		3.5	V	4
MOD-DEF1, 2	V _{IL}	0		0.8	V	
Data Input:						
Transmitter Single Ended Input Voltage (TD±)	V _I	250		1200	mV	5
Data Output:						
Receiver Single Ended Output Voltage (RD±)	V _O	160		1000	mV	6

Notes:

1. MSA gives max current at 300 mA.
2. MSA filter is required on host board 10 Hz to 2 MHz.
3. Satisfied after 500 nanoseconds. Within 500 nanoseconds, maximum of 2000 mA and energy of 700 nanojoules.
4. LVTTTL, External 4.7-10 KΩ pull up resistor required on host board to voltage less than V_{CC}+0.3 V.
5. Internally ac coupled and terminated (100 Ω differential).
6. Internally ac coupled and load termination located at the user SERDES.

Transmitter Optical Characteristics for multirate operation at OC-3 (155 Mbit/s) and OC-12 (622 Mbit/s)HFCT-5750TL/T: $T_C = -10\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ HFCT-5750ATL/ATP: $T_C = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$

Parameter	Symbol	Minimum	Typical*	Maximum	Unit	Notes
Optical Output Power	P_{OUT}	-15		-8	dBm	1
Center Wavelength	λ_c	1274		1356	nm	
Spectral Width - RMS						
OC-3	σ			7.7	nm	2
OC-12				2.5		
Optical Rise Time	t_r			400	ps	3
Optical Fall Time	t_f			400	ps	3
Tx disable OFF power	P_{OFF}			-45	dBm	
Extinction Ratio	E_r	8.2			dB	
Eye Mask Margin	EMM	30			%	4
Jitter Generation	pk to pk			70	mUI	5
	RMS			7	mUI	5

*Typicals indicated expected values for room temperature measurements $+25\text{ }^{\circ}\text{C}$ **Notes:**

1. The output power is coupled into a 1 m single mode fiber. Minimum output optical level is at end of life
2. The relationship between FWHM and RMS values for spectral width can be derived from the Gaussian shaped spectrum which results in $RMS = FWHM/2.35$
3. These are unfiltered 20-80% values at OC-12 operation only.
4. 30% margin to eye mask in Telcordia GR-253-CORE and ITU-T G.957
5. Jitter measurements taken with Agilent OMNIBERT 718 in accordance with GR253

Receiver Optical Characteristics for multirate operation at OC-3 (155 Mbit/s) and OC-12 (622 Mbit/s)HFCT-5750TL/TP: $T_C = -10\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ HFCT-5750ATL/ATP: $T_C = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Receiver Sensitivity	$P_{IN,MIN}$			-28	dBm	1
Receiver Overload	$P_{IN,MAX}$	-8			dBm	
Input Operating Wavelength	λ	1261		1360	nm	
LOS Deassert	P_{LOSD}			-28.5	dBm	
LOS Assert	P_{LOSA}	-45			dBm	
LOS Hysteresis	P_H	0.5		4	dB	

Notes:

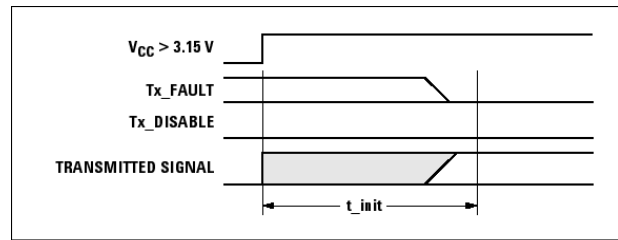
1. The sensitivity is specified for BER of 1×10^{-10} , measured with Tx powered and carrying data.

Transceiver Timing Characteristics for multirate operation at OC-3 (155 Mbit/s) and OC-12 (622 Mbit/s)

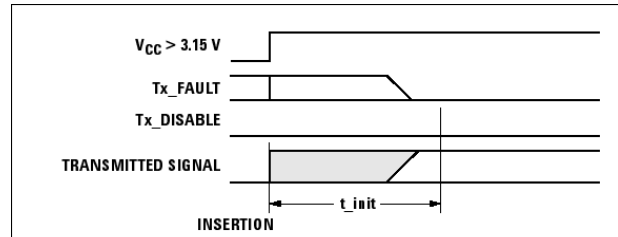
Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Tx Disable Assert Time	t_{off}			10	μs	1
Tx Disable Negate Time	t_{on}			1	ms	2
Time to initialize, including reset of Tx-Fault	t_{init}			300	ms	3
Tx Fault Assert Time	t_{fault}			100	μs	4
Tx Disable to Reset	t_{reset}	10			μs	5
LOS Assert Time	t_{loss_on}	2.3		100	μs	6
LOS Deassert Time	t_{loss_off}			100	μs	7
Serial ID Clock Rate	f_{serial_clock}			100	kHz	

Notes:

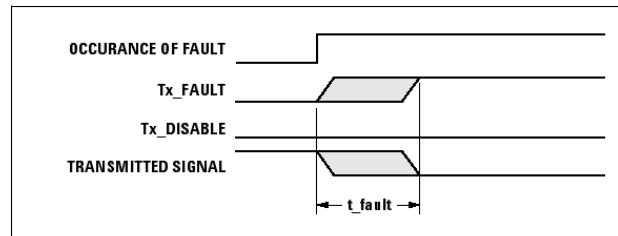
1. Time from rising edge of Tx Disable to when the optical output falls below 10% of nominal.
2. Time from falling edge of Tx Disable to when the modulated optical output rises above 90% of nominal.
3. From power on or negation of Tx Fault using Tx Disable.
4. Time from fault to Tx fault on.
5. Time Tx Disable must be held high to reset Tx_fault.
6. Time from LOS state to Rx LOS assert.
7. Time from non-LOS state to RX LOS deassert.



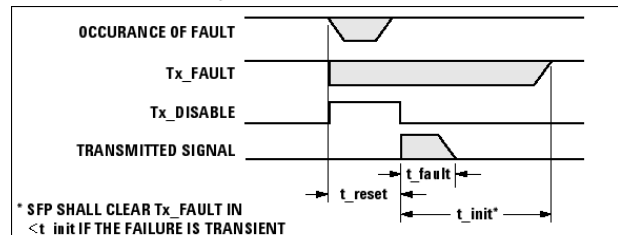
t-init: TX DISABLE NEGATED



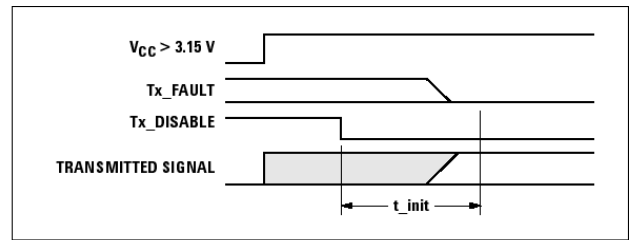
t-init: TX DISABLE NEGATED, MODULE HOT PLUGGED



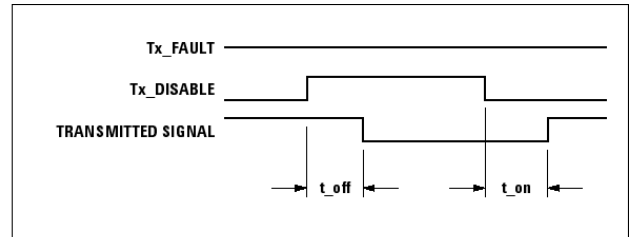
t-fault: TX FAULT ASSERTED, TX SIGNAL NOT RECOVERED



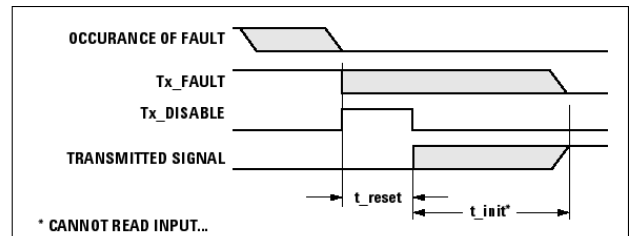
t-fault: TX DISABLE ASSERTED THEN NEGATED, TX SIGNAL NOT RECOVERED



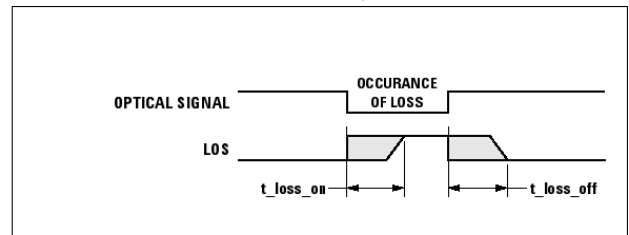
t-init: TX DISABLE ASSERTED



t-off & t-on: TX DISABLE ASSERTED THEN NEGATED



t-reset: TX DISABLE ASSERTED THEN NEGATED, TX SIGNAL RECOVERED



t-loss-on & t-loss-off

Figure 5. Timing Diagrams

Regulatory Compliance

Electrostatic Discharge

There are two conditions in which immunity to ESD damage is important. The first condition is during handling of the transceiver prior to insertion into the transceiver port. To protect the transceiver, it is important to use normal ESD handling precautions. The ESD sensitivity of the HFCT-5750xxx is compatible with typical industry production environments. The second condition is static discharges to the exterior of the host equipment chassis after installation. To the extent that the duplex LC optical interface is exposed to the outside of the host equipment chassis, it may be subject to system-level ESD requirements. The ESD performance of the HFCT-5750xxx exceeds typical industry standards.

Immunity

Equipment hosting the HFCT-5750xxx modules will be subjected to radio-frequency electromagnetic fields in some environments. These transceivers have good immunity to such fields due to their shielded design.

Eye Safety

These 1300 nm FP laser based transceivers provide Class 1 eye safety by design. Agilent has tested the transceiver design for compliance with the requirements listed in Table 3 under normal operating conditions and under a single fault condition.

Electromagnetic Interference (EMI)

Most equipment designs utilizing these high-speed transceivers from Agilent will be required to meet the requirements of FCC in the United States, CENELEC EN55022 (CISPR 22) in Europe and VCCI in Japan.

The metal housing and shielded design of the HFCT-5750xxx minimize the EMI challenge facing the host equipment designer. These transceivers provide superior EMI performance. This greatly assists the designer in the management of the overall system EMI performance.

Table 3. Regulatory Compliance

Feature	Test Method	Performance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883C Method 3015	Class 1 (>2000 Volts)
Electrostatic Discharge (ESD) to the Duplex LC Receptacle	Belcore GR1089-CORE	25 kV Air Discharge 10 Zaps at 8 kV (contact discharge) on the electrical faceplate on panel.
Electromagnetic Interference (EMI)	FCC Class B	Applications with high SFP port counts are expected to be compliant; however, margins are dependent on customer board and chassis design.
Immunity	Variation of IEC 61000-4-3	No measurable effect from a 10 V/m field swept from 80 to 1000 MHz applied to the transceiver without a chassis enclosure.
Eye Safety	US FDA CDRH AEL Class 1 EN (IEC) 60825-1, 2, EN60950 Class 1	CDRH certification # 9521220-95 TUV file # 933/510307/02
Component Recognition	Underwriter's Laboratories and Canadian Standards Association Joint Component Recognition for Information Technology Equipment Including Electrical Business Equipment	UL file # E173874

Mechanical Dimensions

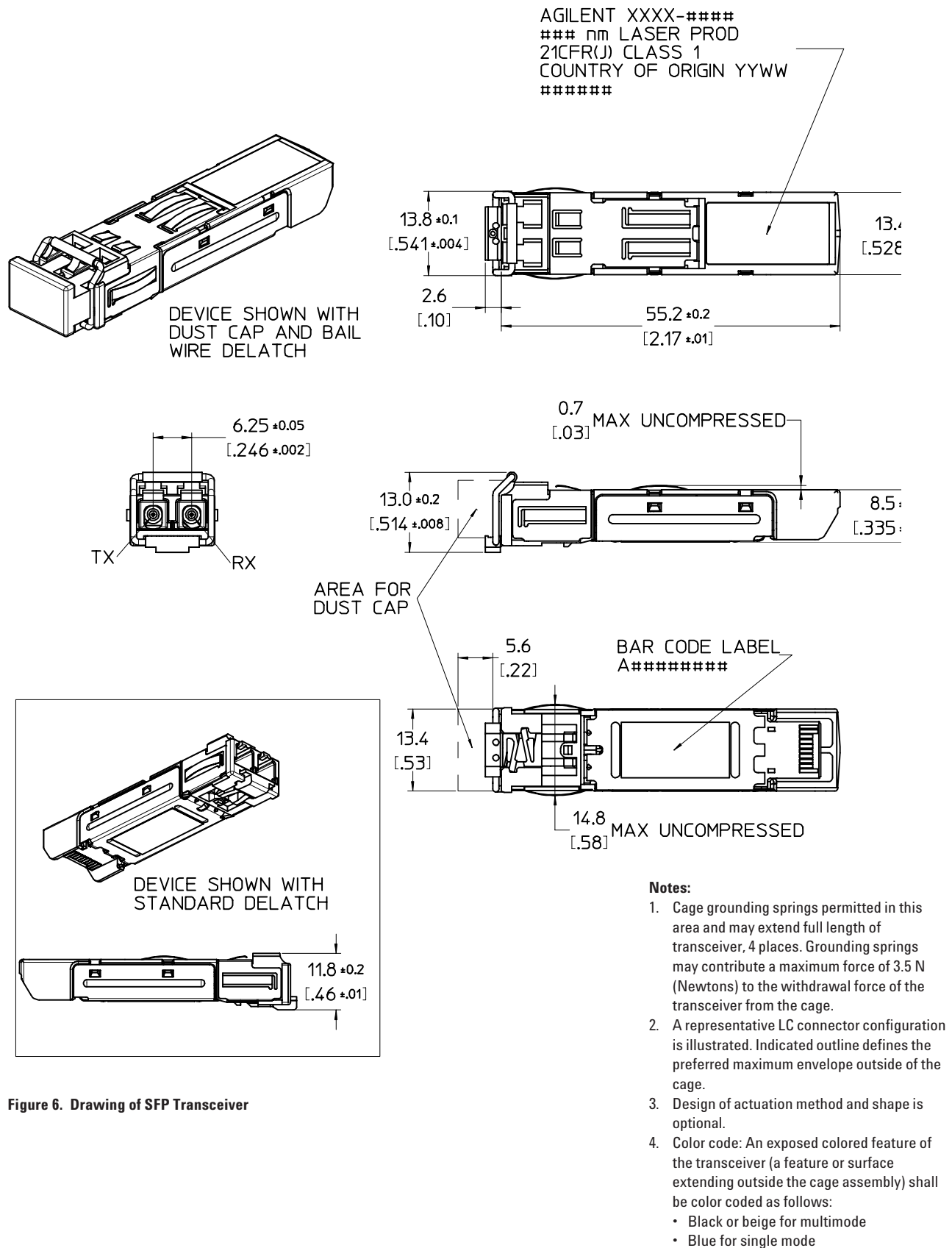
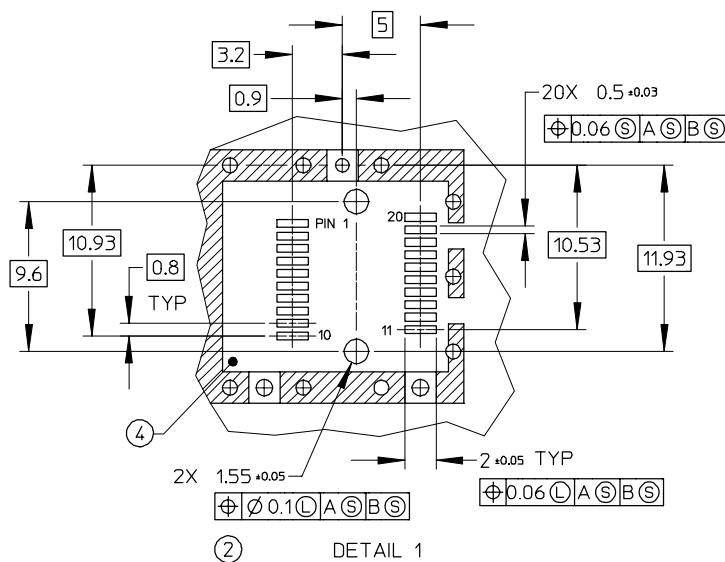
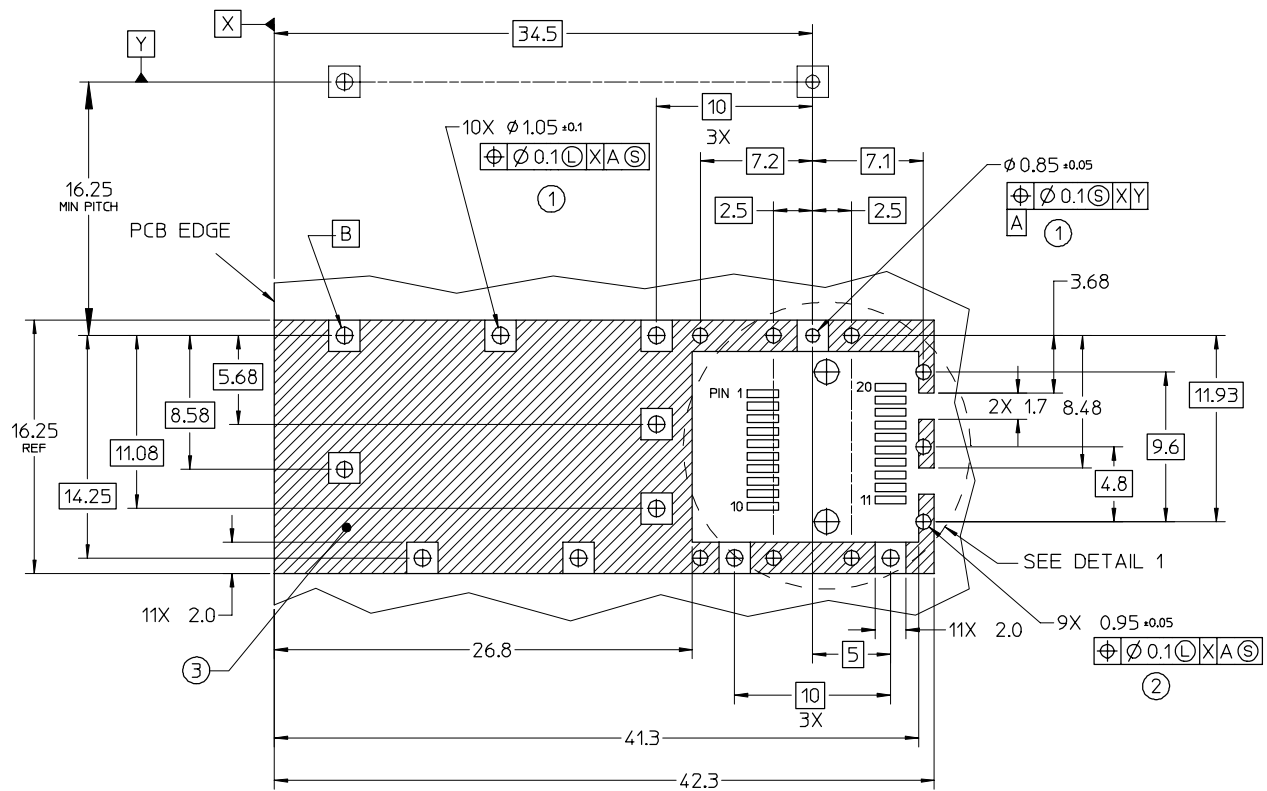


Figure 6. Drawing of SFP Transceiver



NOTES:

PADS AND VIAS ARE CHASSIS GROUND.

- ① THROUGH HOLES, PLATING OPTIONAL.
- ② HATCHED AREA DENOTES COMPONENT AND TRACE KEEPOUT (EXCEPT CHASSIS GROUND).
- ③ AREA DENOTES COMPONENT KEEPOUT (TRACES ALLOWED).

DIMENSIONS ARE IN MILLIMETERS

Figure 7. SFP host board mechanical layout

Application Information

The Applications Engineering Group at Agilent is available to assist you with technical understanding and design trade-offs associated with these transceivers. You can contact them through your Agilent sales representative.

The following information is provided to answer some of the most common questions about the use of parts.

Optical Power Budget

The worst-case Optical Power Budget (OPB) in dB for a fiber-optic link is determined by the difference between the minimum transmitter output optical power (dBm avg) and the lowest receiver sensitivity (dBm avg). This OPB provides the necessary optical signal range to establish a working fiber-optic link. The OPB is allocated for the fiber-optic cable length and the corresponding link penalties. For proper link performance, all penalties that affect the link performance must be accounted for within the link optical power budget.

Process Plug

This transceiver is supplied with a process plug for protection of the optical port within the LC connector receptacle. It is made of a high-temperature, molded sealing material that can withstand +85 °C.

Recommended Cleaning/Degreasing Chemicals

Alcohols: methyl, isopropyl, isobutyl.

Aliphatics: hexane, heptane.

Other: naphtha.

Do not use partially halogenated hydrocarbons such as 1, 1.1 trichloroethane, ketones such as MEK, acetone, chloroform, ethyl acetate, methylene dichloride, phenol, methylene chloride, or N-methylpyrrolidone. Also, Agilent does not recommend the use of cleaners that use halogenated hydrocarbons because of their potential environmental harm.

LC SFP Cleaning Recommendations

In the event of contamination of the optical ports, the recommended cleaning process is the use of forced nitrogen. If contamination is thought to have remained, the optical ports can be cleaned using a NTT international Cletop stick type (diam. 1.25 mm) and HFE7100 cleaning fluid.

Evaluation Kit

An evaluation board (HFBR-0571) is available via your Agilent Representative. Full details can be found in application note 1237.

Reference Designs

Details to be published shortly.

Caution

There are no user serviceable parts nor any maintenance required for the HFCT-5750xxx. Tampering with or modifying the performance of the HFCT-5750xxx will result in voided product warranty. It may also result in improper operation of the HFCT-5750xxx circuitry, and possible overstress of the laser source. Device degradation or product failure may result. Connection of the HFCT-5750xxx to a non-approved optical source, operating above the recommended absolute maximum conditions or operating the HFCT-5750xxx in a manner inconsistent with its design and function may result in hazardous radiation exposure and may be considered an act of modifying or manufacturing a laser product. The person(s) performing such an act are required by law to recertify and reidentify the laser product under the provisions of U.S. 21 CFR (Subchapter J) and the TUV.

Ordering Information

1300nm FP Laser (Operating Case Temperature -10 to +85 °C)

HFCT-5750TL IR, standard de-latch

HFCT-5750TP IR, bail de-latch

1300nm FP Laser (Operating Case Temperature -40 to +85 °C)

HFCT-5750ATL IR, standard de-latch

HFCT-5750ATP IR, bail de-latch

Class 1 Laser Product: This product conforms to the applicable requirements of 21 CFR 1040 at the date of manufacture

Date of Manufacture: _____

Agilent Technologies Inc., No 1 Yishun Ave 7, Singapore

Handling Precautions

1. The HFCT-5750xxx can be damaged by current surges or overvoltage. Power supply transient precautions should be taken.
2. Normal handling precautions for electrostatic sensitive devices should be taken.

[www.agilent.com/ semiconductors](http://www.agilent.com/semiconductors)

For product information and a complete list of distributors, please go to our web site.

For technical assistance call:

Americas/Canada: +1 (800) 235-0312 or

(916) 788-6763

Europe: +49 (0) 6441 92460

China: 10800 650 0017

Hong Kong: (+65) 6756 2394

India, Australia, New Zealand: (+65) 6755 1939

Japan: (+81 3) 3335-8152(Domestic/International), or

0120-61-1280(Domestic Only)

Korea: (+65) 6755 1989

Singapore, Malaysia, Vietnam, Thailand, Philippines,

Indonesia: (+65) 6755 2044

Taiwan: (+65) 6755 1843

Data subject to change.

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Obsoletes: 5988-8989EN

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5988-9311EN



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